

BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu PC3231GV$

GENERAL PURPOSE 5 V 100 MHz AGC AMPLIFIER

DESCRIPTION

The μ PC3231GV is a silicon monolithic IC designed for use as AGC amplifier for digital CATV, cable modem and digital terrestrial systems. This IC consists of gain control amplifier and video amplifier.

The package is 8-pin SSOP (Shrink Small Outline Package) suitable for surface mount.

This IC is manufactured using our 30 GHz fmax UHS0 (Ultra High Speed Process) silicon bipolar process.

This process uses silicon nitride passivation film. This material can protect chip surface from external pollution and prevent corrosion/migration. Thus, this IC has excellent performance, uniformity and reliability.

FEATURES

• Low distortion : IM₃ = 53.5 dBc TYP. @ single-ended output, $V_{out} = 105 \text{ dB}\mu V$ (0.5 V_{p-p}) /tone

Low noise figure : NF = 5.0 dB TYP. @ maximum gain
 Wide AGC dynamic range : GCR_{in} = 61 dB TYP. @ input prescribe
 On-chip video amplifier : V_{out} = 1.0 V_{P-P} TYP. @ single-ended output

Supply voltage : Vcc = 5.0 V TYP.
 Packaged in 8-pin SSOP suitable for surface mounting

APPLICATION

Digital terrestrial TV/Digital CATV/Cable modem receivers

ORDERING INFORMATION

Part Number	Order Number	Package	Marking	Supplying Form
μPC3231GV-E1	μPC3231GV-E1-A	8-pin plastic SSOP (4.45 mm (175)) (Pb-Free)	3231	Embossed tape 8 mm wide Pin 1 indicates pull-out direction of tape Qty 1 kpcs/reel

Remark To order evaluation samples, contact your nearby sales office.

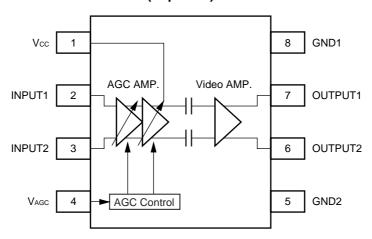
Part number for sample order: μ PC3231GV-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

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INTERNAL BLOCK DIAGRAM AND PIN CONNECTIONS

(Top View)



PRODUCT LINE-UP OF 5 V AGC AMPLIFIER

Part Number	Icc (mA)	G _{мах} (dB)	G _{MIN} (dB)	GCR (dB)	NF (dB)	IM₃ (dBc)	Package
μPC3217GV	23	53	0	53	6.5	50 Note1	8-pin SSOP (4.45 mm (175))
μPC3218GV	23	63	10	53	3.5	50 Note1	
μPC3219GV	36.5	42.5	0	42.5	9.0	58 Note1	
μPC3221GV	33	60	10	50	4.2	56 Note1	
μPC3231GV	36	65	4	61	5.0	53.5 Note2	

Notes 1. f1 = 44 MHz, f2 = 45 MHz, $V_{out} = 0.7 V_{p-p}/tone$, single-ended output

2. f1 = 44 MHz, f2 = 45 MHz, $V_{out} = 0.5$ $V_{p-p}/tone$, single-ended output

PIN EXPLANATIONS

Pin No.	Pin Name	Applied Voltage (V)	Pin Voltage (V) ^{Note}	Function and Application	Internal Equivalent Circuit
1	Vcc	4.5 to 5.5	=	Power supply pin. This pin should be externally equipped with bypass capacitor to minimize ground impedance.	
2	INPUT1		1.32	Signal input pins to AGC amplifier. This pin should be coupled with capacitor for DC cut.	AGC Control
3	INPUT2	-	1.32		2 5 3
4	Vagc	0 to Vcc	-	Gain control pin. This pin's bias govern the AGC output level. Minimum Gain at V _{AGC} : 0 to 0.1 V Maximum Gain at V _{AGC} : 2.7 to 3.3 V Recommended to use AGC voltage with externally resister (example: 1 k Ω).	AGC Amp.
5	GND2	0	-	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible.	
6	OUTPUT2	-	1.91	Signal output pins of video amplifier. This pin should be coupled with capacitor for DC cut.	1
7	OUTPUT1	-	1.91		8
8	GND1	0	_	Ground pin. This pin should be connected to system ground with minimum inductance. Ground pattern on the board should be formed as wide as possible. All ground pins must be connected together with wide ground pattern to decrease impedance difference.	

Note Pin voltage is measured at Vcc = 5.0 V.

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Test Conditions	Ratings	Unit
Supply Voltage	Vcc	T _A = +25°C	6.0	V
Gain Control Voltage Range	VAGC	T _A = +25°C	0 to Vcc	V
Power Dissipation	P□	T _A = +85°C Note	250	mW
Storage Temperature	Tstg		-55 to +150	°C

Note Mounted on double-sided copper-clad $50 \times 50 \times 1.6$ mm epoxy glass PWB

RECOMMENDED OPERATING RANGE

Parameter	Symbol	Test Conditions	MIN.	TYP.	MAX.	Unit
Supply Voltage	Vcc		4.5	5.0	5.5	V
Operating Ambient Temperature	TA	Vcc = 4.5 to 5.5 V	-40	+25	+85	°C
Gain Control Voltage Range	Vagc		0	-	3.3	V
Operating Frequency Range	fвw		30	1	90	MHz

ELECTRICAL CHARACTERISTICS

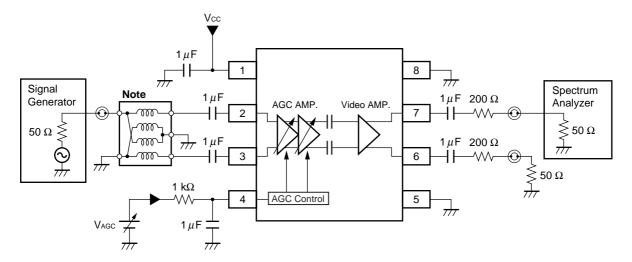
(Ta = +25°C, Vcc = 5 V, f = 45 MHz, Zs = 50 Ω , ZL = 250 Ω , single-ended output)

Parameter	Symbol	Test Conditions		MIN.	TYP.	MAX.	Unit
DC Characteristics							
Circuit Current	Icc	Vcc = 5 V, No input signal	Note 1	28	36	44	mA
AGC Voltage High Level	VAGC (H)	@ Maximum gain	Note 1	2.7	-	3.3	٧
AGC Voltage Low Level	VAGC (L)	@ Minimum gain	Note 1	0	=	0.1	٧
RF Characteristics							
IF Input Voltage Range	fıFin	fc = -3 dB	Note 1	30	-	90	MHz
Maximum Voltage Gain	Gмах	Vagc = 2.7 V, Pin = -60 dBm	Note 1	62.5	65	67.5	dB
Minimum Voltage Gain	Gмin	Vagc = 0.1 V, Pin = -30 dBm	Note 1	0	4	7	dB
Gain Control Range (input prescribe)	GCRin	Vagc = 0.1 to 2.7 V	Note 1	55.5	61	-	dB
Gain Control Range (output prescribe)	GCRout	$V_{out} = 1.0 V_{p-p}$	Note 1	45	55	-	dB
Output Voltage	Vout	P _{in} = -61 to -6 dBm	Note 1	_	1.0	-	V _{p-p}
Maximum Output Voltage	Voclip	Vagc = 3.0 V	Note 1	2.0	3.3	-	V _{p-p}
Noise Figure	NF	Vagc = 3.0 V	Note 2	-	5.0	6.5	dB
3rd Order Intermodulation Distortion	IMз	f1 = 44 MHz, f2 = 45 MHz, $P_{in} = -20 \text{ dBm/tone},$ $V_{out} = 105 \text{ dB}_{\mu}V (0.5 V_{p-p}) / \text{tor}$	ne Note 1	50	53.5	-	dBc
Input Impedance	Zin	Vagc = 0 V	Note 3	=	1.35//6	=	kΩ//pF

Notes 1. By measurement circuit 1

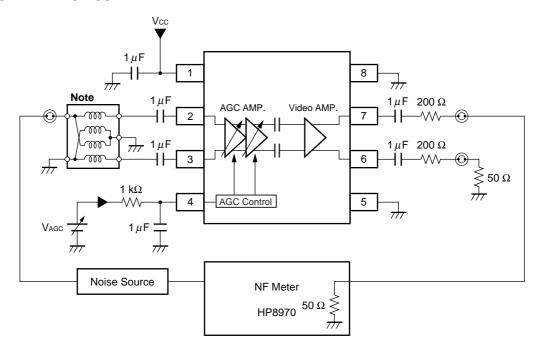
- 2. By measurement circuit 2
- 3. By measurement circuit 3

MEASUREMENT CIRCUIT 1



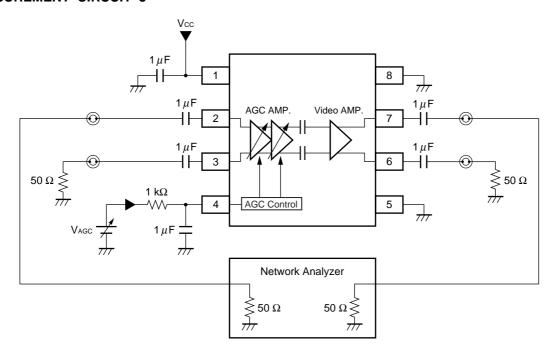
Note Balun Transformer: TOKO 617DB-1674 B4F (Double balanced type)

MEASUREMENT CIRCUIT 2

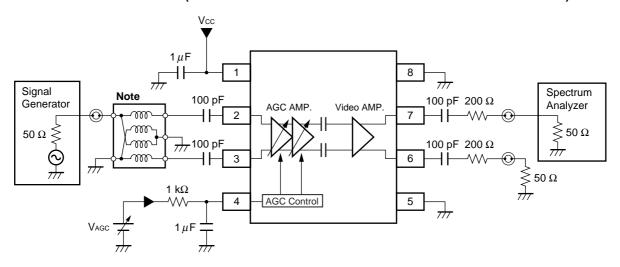


Note Balun Transformer: TOKO 617DB-1674 B4F (Double balanced type)

MEASUREMENT CIRCUIT 3

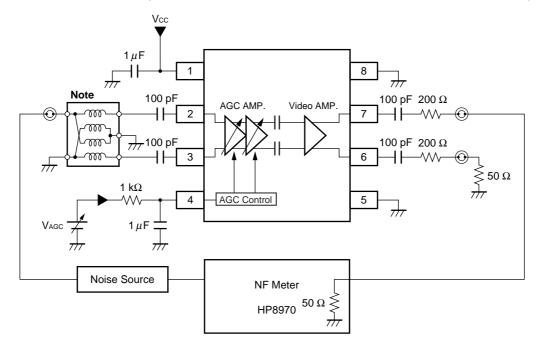


MEASUREMENT CIRCUIT 4 (PRESSURE IMPROVEMENT RECOMMENDATION CIRCUIT)



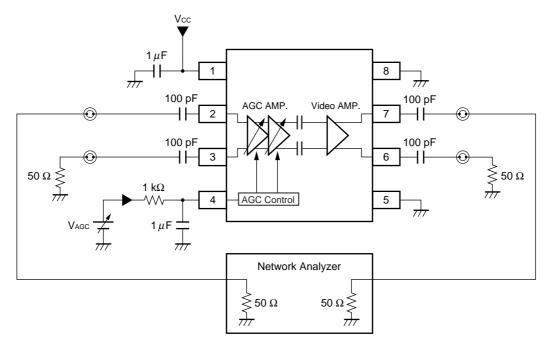
Note Balun Transformer: TOKO 617DB-1674 B4F (Double balanced type)

MEASUREMENT CIRCUIT 5 (PRESSURE IMPROVEMENT RECOMMENDATION CIRCUIT)



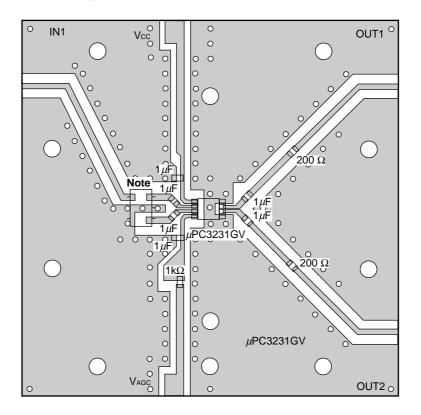
Note Balun Transformer: TOKO 617DB-1674 B4F (Double balanced type)

MEASUREMENT CIRCUIT 6 (PRESSURE IMPROVEMENT RECOMMENDATION CIRCUIT)



The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD (MEASUREMENT CIRCUIT 1)

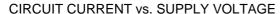


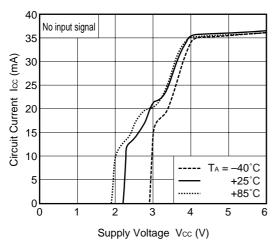
Note Balun Transformer

Remarks

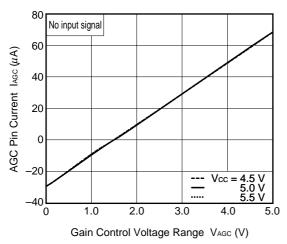
Back side: GND pattern
 Au plated on pattern
 O: Through hole

TYPICAL CHARACTERISTICS (TA = +25°C, unless otherwise specified)

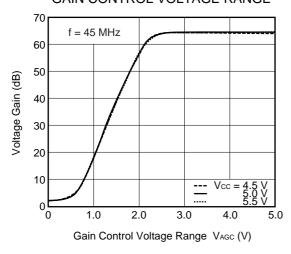




AGC PIN CURRENT vs. GAIN CONTROL VOLTAGE RANGE

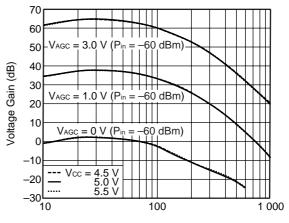


VOLTAGE GAIN vs. GAIN CONTROL VOLTAGE RANGE



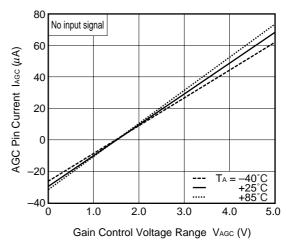
Remark The graphs indicate nominal characteristics.

VOLTAGE GAIN vs. FREQUENCY

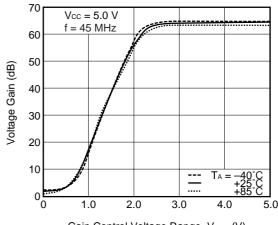


Frequency f (MHz)

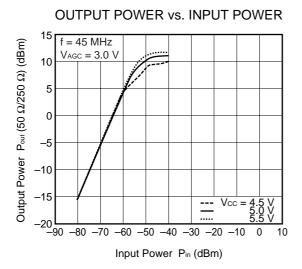
AGC PIN CURRENT vs. GAIN CONTROL VOLTAGE RANGE

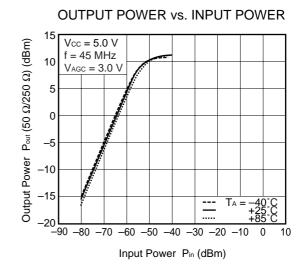


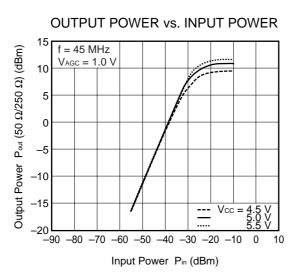
VOLTAGE GAIN vs. GAIN CONTROL VOLTAGE RANGE

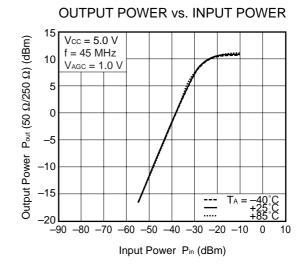


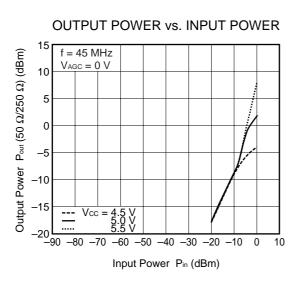
Gain Control Voltage Range VAGC (V)

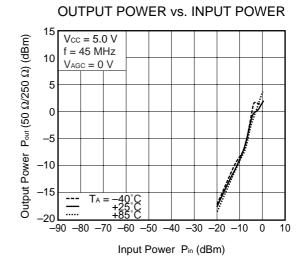




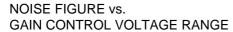


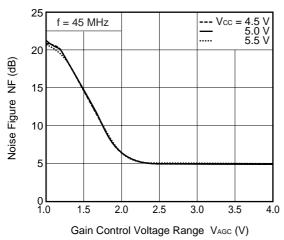




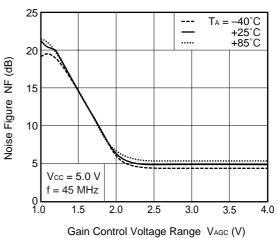


Remark The graphs indicate nominal characteristics.

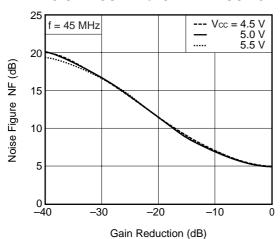




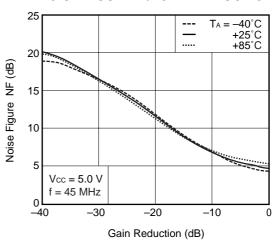
NOISE FIGURE vs. GAIN CONTROL VOLTAGE RANGE



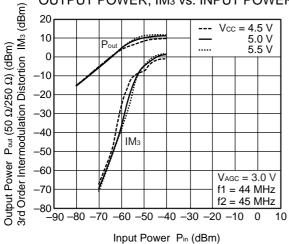
NOISE FIGURE vs. GAIN REDUCTION



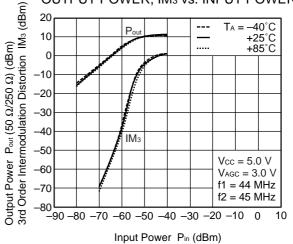
NOISE FIGURE vs. GAIN REDUCTION



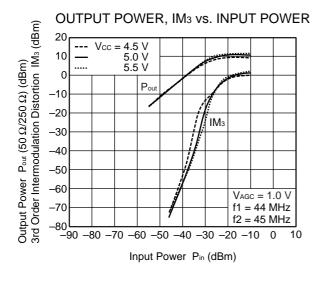
OUTPUT POWER, IM3 vs. INPUT POWER

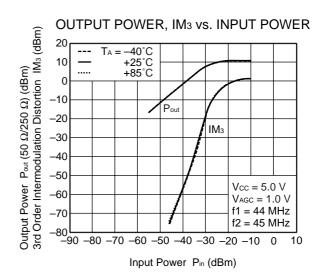


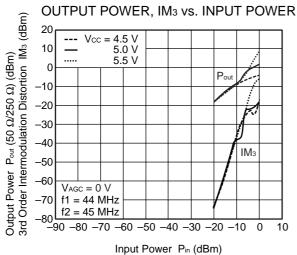
OUTPUT POWER, IM3 vs. INPUT POWER

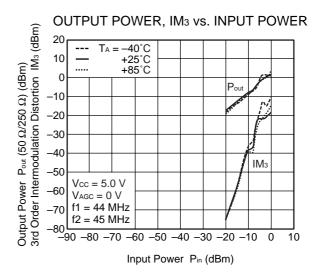


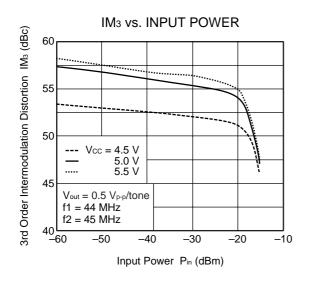
Remark The graphs indicate nominal characteristics.

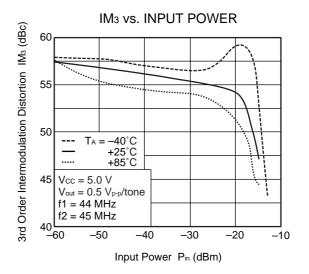








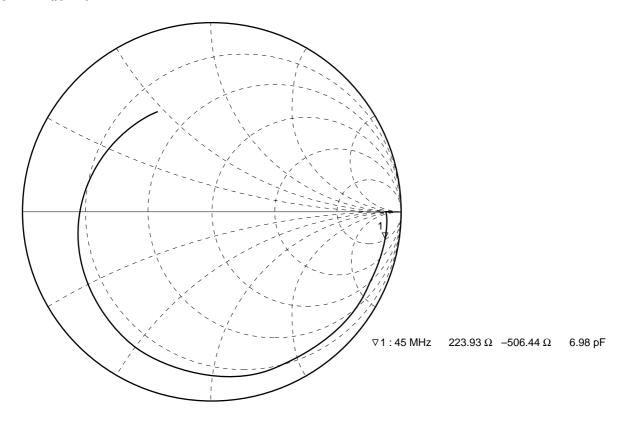




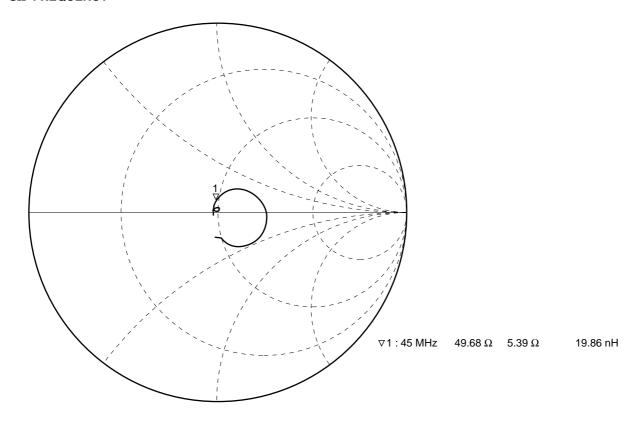
Remark The graphs indicate nominal characteristics.

S-PARAMETERS (Ta = +25°C, Vcc = 5.0 V, Vagc = 0 V)

S₁₁-FREQUENCY

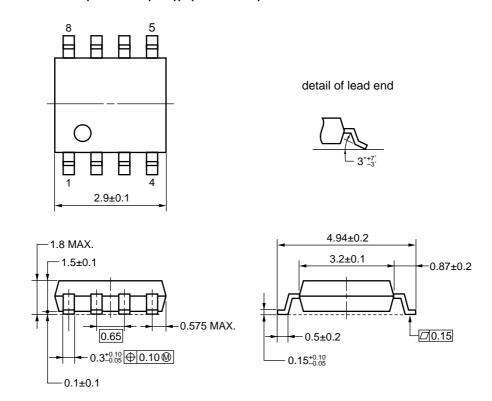


S₂₂-FREQUENCY



PACKAGE DIMENSIONS

8-PIN PLASTIC SSOP (4.45 mm (175)) (UNIT: mm)



NOTES ON CORRECT USE

- (1) Observe precautions for handling because of electro-static sensitive devices.
- (2) Form a ground pattern as widely as possible to minimize ground impedance (to prevent undesired oscillation). All the ground pins must be connected together with wide ground pattern to decrease impedance difference.
- (3) The bypass capacitor should be attached to Vcc line.

RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

Soldering Method	Soldering Conditions		Condition Symbol
Infrared Reflow	Peak temperature (package surface temperature) Time at peak temperature Time at temperature of 220°C or higher Preheating time at 120 to 180°C Maximum number of reflow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 60 seconds or less : 120±30 seconds : 3 times : 0.2%(Wt.) or below	IR260
Wave Soldering	Peak temperature (molten solder temperature) Time at peak temperature Preheating temperature (package surface temperature) Maximum number of flow processes Maximum chlorine content of rosin flux (% mass)	: 260°C or below : 10 seconds or less : 120°C or below : 1 time : 0.2%(Wt.) or below	WS260
Partial Heating	Peak temperature (pin temperature) Soldering time (per side of device) Maximum chlorine content of rosin flux (% mass)	: 350°C or below : 3 seconds or less : 0.2%(Wt.) or below	HS350

Caution Do not use different soldering methods together (except for partial heating).

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CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL's understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

Restricted Substance per RoHS	Concentration Limit per RoHS (values are not yet fixed)		on contained devices	
Lead (Pb)	< 1000 PPM	-A Not Detected	-AZ (*)	
Mercury	< 1000 PPM	Not Detected		
Cadmium	< 100 PPM	Not Detected		
Hexavalent Chromium	< 1000 PPM	Not Detected		
PBB	< 1000 PPM	Not De	etected	
PBDE	< 1000 PPM	Not Detected		

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